

FL500PP-GF

FL500PP-GF is an **engineering-grade** composite made with glass fiber (GF) and is designed to provide robust impact strength performance while maintaining a high degree of printability for complex structures.

FL500PP-GF provides engineering level performance without compromising any of PP's inherent properties which include light weight, water resistance (no drying needed), chemical resistance, and impact resistance.

Recommended Print Settings

| Parameter | Units | Range | |
|--|-----------|---|--|
| Extruder Temperature | °C | 240 - 260 | |
| Nozzle Size (Material) | mm | ≥0.6 (Hardened Nozzle) | |
| Recommended Bed Temperature / Substrate ^a | °C / Type | 80 / PP bed adhesion solution stick (water soluble) | |
| Alternate Bed Temperature / Substrate b | °C / Type | 20-40 / Multi-purpose adhesive spray | |
| Printing Speed (First Layer) | mm/s | 35 - 65 (60% speed) | |
| Fan Speed | % | 50 – 100 | |
| Extrusion Multiplier | _ | 0.90 – 1.10 | |
| Overlap Percentage | % | 0 – 20 | |
| Brim | Layers | 0 – 5 | |
| Support/Raft Air Gap | mm | 0.2 or single layer thickness | |

^a Recommended to use a bed adhesive specifically designed for Polypropylene filaments.

Printed Part Properties

| Parameter | Method | Units | Value |
|---|--------|---------|-------|
| Density | D 792 | g/cm³ | 1.06 |
| Hardness | D 2240 | Shore D | 63 |
| Ultimate Tensile Strength* | D 638 | MPa | 46 |
| Tensile Elongation at Break* | D 638 | % | 2.2 |
| Young's Modulus * | D 638 | GPa | 5.2 |
| Flexural Modulus – Chord Modulus * | D 790 | GPa | 4.1 |
| Izod Impact Strength at 23℃ * | D 256 | J/m | 189 |
| Deflection Temperature at 0.455 MPa, 12.7mm | D 648 | °C | 154 |
| Vicat Softening Temperature at 10 N | D 1525 | °C | 157 |

^{*} Printed part properties obtained using test specimens printed in X-Y direction under the following conditions: printing temperature 240°C, bed temperature 85°C, print speed 1800 mm/min, 100% of grid (90°) infill, 0 perimeter/shell layers, 0.60 mm hardened nozzle and 0.2 mm layer height.

Notes

- 1. Recommended process conditions and printed part properties may be changed at any moment without previous communication from Braskem.
- 2. This resin does not contain the substance Bisphenol A (BPA, CAS: 80-05-7) in its composition.
- 3. For information on about safety, handling, individual protection, first aids and waste disposal, please see MSDS.
- 4. In case of questions regarding utilization or regulatory information, please contact our technical assistance area.

b Traditional bed adhesive solutions used for PLA and ABS (such as blue tape, glue sticks, hair spray) will not properly adhere PP to the built plate.